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FAN54015 USB-Compliant Single-Cell Li-Ion Switching Charger with USB-OTG Boost Regulator

Features

- Fully Integrated, High-Efficiency Charger for Single-Cell Li-Ion and Li-Polymer Battery Packs
- Faster Charging than Linear
- Charge Voltage Accuracy: $\pm 0.5\%$ at 25 \degree C \pm 1% from 0 to 125°C
- 5% Input Current Regulation Accuracy
- 5% Charge Current Regulation Accuracy
- 20 V Absolute Maximum Input Voltage
- 6 V Maximum Input Operating Voltage
- 1.45 A Maximum Charge Rate
- Programmable through High-Speed I^2C Interface (3.4 Mb/s) with Fast Mode Plus Compatibility
	- Input Current
	- Fast-Charge / Termination Current
	- Charger Voltage
	- Termination Enable
- 3 MHz Synchronous Buck PWM Controller with Wide Duty Cycle Range
- Small Footprint 1 μ H External Inductor
- Safety Timer with Reset Control
- 1.8 V Regulated Output from VBUS for Auxiliary Circuits
- Dynamic Input Voltage Control
- Low Reverse Leakage to Prevent Battery Drain to VBUS
- 5 V, 500 mA Boost Mode for USB OTG for 3.0 V to 4.5 V Battery Input
- Available in a 1.96 x 1.87 mm, 20-bump, 0.4 mm Pitch WLCSP Package

Applications

- Cell Phones, Smart Phones, PDAs
- Tablet, Portable Media Players
- Gaming Device, Digital Cameras

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Description

The FAN54015 combines a highly integrated switch-mode charger, to minimize single-cell Lithium-ion (Li-ion) charging time from a USB power source, and a boost regulator to power a USB peripheral from the battery.

The charging parameters and operating modes are programmable through an I²C Interface that operates up to 3.4 Mbps. The charger and boost regulator circuits switch at 3 MHz to minimize the size of external passive components.

The FAN54015 provides battery charging in three phases: conditioning, constant current and constant voltage.

To ensure USB compliance and minimize charging time, the input current limit can be changed through the I^2C by the host processor. Charge termination is determined by a programmable minimum current level. A safety timer with reset control provides a safety backup for the I^2C host. Charge status is reported to the host through the I^2C port.

The integrated circuit (IC) automatically restarts the charge cycle when the battery falls below an internal threshold. If the input source is removed, the IC enters a high-impedance mode, preventing leakage from the battery to the input. Charge current is reduced when the die temperature reaches 120°C, protecting the device and PCB from damage.

The FAN54015 can operate as a boost regulator on command from the system. The boost regulator includes a soft-start that limits inrush current from the battery and uses the same external components used for charging the battery.

Ordering Information

Note:

1. FAN54015BUCX includes backside lamination.

Table 1. Feature Summary

Note:

2. A "special charger" is a current-limited charger that is not a USB compliant source.

Block Diagram

Figure 2. IC and System Block Diagram

Note:

3. A 6.3 V rating is sufficient for C_{MID} because PMID is protected from over-voltage surges on VBUS by Q3 [\(Figure 2\)](#page-2-2).

Figure 3**. WLCSP-20 Pin Assignments**

Pin Definitions

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Note:

4. Lesser of 6.5 V or $V_1 + 0.3$ V.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Thermal Properties

Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 2s2p boards in accordance to JEDEC standard JESD51. Special attention must be paid not to exceed junction temperature TJ(max) at a given ambient temperature TA. *For measured data, see [Table 11.](#page-24-1)*

Electrical Specifications

Unless otherwise specified: according to the circuit of [Figure 1;](#page-1-0) recommended operating temperature range for TJ and TA; V_{BUS}=5.0 V; HZ_MODE; OPA_MODE=0; (Charge Mode); SCL, SDA, OTG=0 or 1.8 V; and typical values are for T_J=25°C.

Electrical Specifications

Unless otherwise specified: according to the circuit of [Figure 1;](#page-1-0) recommended operating temperature range for T_J and T_{A} ; V_{BUS}=5.0 V; HZ_MODE; OPA_MODE=0; (Charge Mode); SCL, SDA, OTG=0 or 1.8 V; and typical values are for T_J=25°C.

Continued on the following page…

Electrical Specifications

Unless otherwise specified: according to the circuit of [Figure 1;](#page-1-0) recommended operating temperature range for TJ and TA; V_{BUS}=5.0 V; HZ_MODE; OPA_MODE=0; (Charge Mode); SCL, SDA, OTG=0 or 1.8 V; and typical values are for T_J=25°C.

Notes:

5. Negative current is current flowing from the battery to VBUS (discharging the battery).

6. $Q2$ always turns on for 60 ns, then turns off if current is below I_{SYNC} .
7. Guaranteed by design; not tested in production.

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8. This tolerance (%) applies to all timers on the IC

This tolerance (%) applies to all timers on the IC, including soft-start and deglitching timers.

Boost

Regulator

I ²C Timing Specifications

Guaranteed by design.

Continued on the following page…

I ²C Timing Specifications

Guaranteed by design.

Timing Diagrams

Note A: First rising edge of SCLH after Repeated Start and after each ACK bit.

Regulator

Charge Mode Typical Characteristics

Unless otherwise specified, circuit of [Figure 1,](#page-1-0) $V_{OREG} = 4.2$ V, $V_{BUS} = 5.0$ V, and $T_A = 25^{\circ}$ C.

Figure 8. Charger Efficiency, No IINLIM, IOCHARGE=1450 mA Figure 9. Charger Efficiency vs. VBUS, IINLIM=500 mA

Figure 7. Battery Charge Current vs. V_{BUS} with IINLIM=500 mA

 $2.30V$

Charge Mode Typical Characteristics

Unless otherwise specified, circuit of [Figure 1,](#page-1-0) $V_{OREG} = 4.2$ V, $V_{BUS} = 5.0$ V, and $T_A = 25^{\circ}$ C.

Figure 18. No Battery, V_{BUS} at Power Up

Boost Mode Typical Characteristics

Unless otherwise specified, using circuit of [Figure 1,](#page-1-0) $V_{BAT}=3.6$ V, $T_A=25^{\circ}$ C.

Figure 19. Efficiency vs. VBAT Figure 20. Efficiency Over Temperature

Figure 21. Output Regulation vs. V_{BAT} Figure 22. Output Regulation Over Temperature

FAN54015 — USB-Compliant Single-Cell Li-Ion Switching Charger with USB-OTG Boost Regulator

Circuit Description / Overview

When charging batteries with a current-limited input source, such as USB, a switching charger's high efficiency over a wide range of output voltages minimizes charging time.

FAN54015 combines a highly integrated synchronous buck regulator for charging with a synchronous boost regulator, which can supply 5 V to USB On-The-Go (OTG) peripherals. The regulator employs synchronous rectification for both the charger and boost regulators to maintain high efficiency over a wide range of battery voltages and charge states.

The FAN54015 has three operating modes:

- 1. Charge Mode: Charges a single-cell Li-ion or Li-polymer battery.
- 2. Boost Mode: Provides 5 V power to USB-OTG with an integrated synchronous rectification boost regulator using the battery as input.
- 3. High-Impedance Mode: Both the boost and charging circuits are OFF in this mode. Current flow from VBUS to the battery or from the battery to VBUS is blocked in this mode. This mode consumes very little current from VBUS or the battery.

Note: Default settings are denoted by **bold typeface**.

Charge Mode

In Charge Mode, FAN54015 employs four regulation loops:

- 1. Input Current: Limits the amount of current drawn from VBUS. This current is sensed internally and can be programmed through the I^2C interface.
- 2. Charging Current: Limits the maximum charging current. This current is sensed using an external R_{SENSE} resistor.
- 3. Charge Voltage: The regulator is restricted from exceeding this voltage. As the internal battery voltage rises, the battery's internal impedance and R_{SENSE} work in conjunction with the charge voltage regulation to decrease the amount of current flowing to the battery. Battery charging is completed when the voltage across R_{SENSE} drops below the I_{TERM} threshold.
- 4. Temperature: If the IC's junction temperature reaches 120°C, charge current is reduced until the IC's temperature stabilizes at 120°C.
- 5. An additional loop limits the amount of drop on VBUS to a programmable voltage (V_{SP}) to accommodate "special chargers" that limit current to a lower current than might be available from a "normal" USB wall charger.

Battery Charging Curve

If the battery voltage is below V_{SHORT} , a linear current source pre-charges the battery until V_{BAT} reaches V_{SHORT} . The PWM charging circuit is then started and the battery is charged with a constant current if sufficient input power is available. The current slew rate is limited to prevent overshoot.

The FAN54015 is designed to work with a current-limited input source at VBUS. During the current regulation phase of charging, I_{INLIM} or the programmed charging current limits the amount of current available to charge the battery and power the system. The effect of I_{INLIM} on I_{CHARGE} can be seen in [Figure 34.](#page-16-0)

Figure 33. Charge Curve, I_{CHARGE} Not Limited by I_{INLIM}

Figure 34. Charge Curve, I_{INLIM} **Limits ICHARGE**

Assuming that V_{OREG} is programmed to the cell's fully charged "float" voltage, the current that the battery accepts with the PWM regulator limiting its output (sensed at VBAT) to V_{OREG} declines, and the charger enters the voltage regulation phase of charging. When the current declines to the programmed I_{TERM} value, the charge cycle is complete. Charge current termination can be disabled by resetting the TE bit (REG1[3]).

The charger output or "float" voltage can be programmed by the OREG bits from 3.5 V to 4.44 V in 2 0mV increments, as shown in [Table 3.](#page-17-0)

Table 3. OREG Bits (OREG[7:2]) vs. Charger V_{OUT} **(VOREG) Float Voltage**

The following charging parameters can be programmed by the host through I^2C :

A new charge cycle begins when one of the following occurs:

- The battery voltage falls below V_{OREG} V_{RCH}
- VBUS Power on Reset (POR) clears and the battery voltage is below the weak battery threshold (V_{LOWV}).
- \overline{CE} or HZ_MODE is reset through I^2C write to CONTROL1 (R1) register.

Charge Current Limit (IOCHARGE)

Termination Current Limit

Current charge termination is enabled when TE (REG1[3])=1. Typical termination current values are given in [Table 6.](#page-17-1)

Table 6. I_{TERM} Current as Function of I_{TERM} Bits **(REG4[2:0]) and RSENSE Resistor Values**

When the charge current falls below I_{TERM} , PWM charging stops and the STAT bits change to READY (00) for about 500 ms while the IC determines whether the battery and charging source are still connected. STAT then changes to CHARGE DONE (10), provided the battery and charger are still connected.

PWM Controller in Charge Mode

The IC uses a current-mode PWM controller to regulate the output voltage and battery charge currents. The synchronous rectifier (Q2) has a current limit that which off the FET when the current is negative by more than 140mA peak. This prevents current flow from the battery.

Safety Timer

Section references [Figure 39.](#page-22-0)

At the beginning of charging, the IC starts a 15-minute timer (t_{15MIN}). When this times out, charging is terminated. Writing to any register through I^2C stops and resets the t_{15MIN} timer, which in turn starts a 32-second timer (t_{32S}) . Setting the TMR_RST bit (REG0[7]) resets the t_{32S} timer. If the t_{32S} timer times out; charging is terminated, the registers are set to their default values, and charging resumes using the default values with the t_{15MIN} timer running.

Normal charging is controlled by the host with the t_{32S} timer running to ensure that the host is alive. Charging with the t_{15MIN} timer running is used for charging that is unattended by the host. If the t_{15MIN} timer expires; the IC turns off the charger, sets the \overline{CE} bit, and indicates a timer fault (110) on the FAULT bits (REG0[2:0]). This sequence prevents overcharge if the host fails to reset the t_{32S} timer.

VBUS POR / Non-Compliant Charger Rejection

When the IC detects that V_{BUS} has risen above $V_{IN(MIN)1}$ (4.4 V), the IC applies a 100 Ω load from VBUS to GND. To clear the VBUS POR (Power-On-Reset) and begin charging, VBUS must remain above $V_{IN(MIN)1}$ and below VBUS_{OVP} for t_{VBUS} $_{VALID}$ (30 ms) before the IC initiates charging. The VBUS validation sequence always occurs before charging is initiated or re-initiated (for example, after a VBUS OVP fault or a V_{RCH} recharge initiation).

 t_{VBUS} v_{ALID} ensures that unfiltered 50 / 60 Hz chargers and other non-compliant chargers are rejected.

USB-Friendly Boot Sequence

At VBUS POR, when the battery voltage is above the weak battery threshold (V_{LOWV}), the IC operates in accordance with its I^2C register settings. If $V_{BAT} < V_{LOWV}$, the IC sets all registers to their default values and enables the charger using an input current limit controlled by the OTG pin (100mA if OTG is LOW and 500 mA if OTG is HIGH). This feature can revive a battery whose voltage is too low to ensure reliable host operation. Charging continues in the absence of host communication even after the battery has reached V_{OREG} , whose default value is 3.54 V, and the charger remains active until t_{15MIN} times out. Once the host processor begins writing to the IC, charging parameters are set by the host, which must continually reset the t_{32S} timer to continue charging using the programmed charging parameters. If t_{32S}.times out, the register defaults are loaded, the FAULT bits are set to 110, STAT is pulsed HIGH, and charging continues with default charge parameters.

Input Current Limiting

To minimize charging time without overloading VBUS current limitations, the IC's input current limit can be programmed by the I_{INLIM} bits (REG1[7:6]).

Table 7. Input Current Limit

The OTG pin establishes the input current limit when t_{15MIN} is running.

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FAN54015 —

Special Charger

The FAN54015 has additional functionality to limit input current in case a current-limited "special charger" is supplying VBUS. These slowly increase the charging current until either:

- I_{INLIM} or I_{OCHARGE} is reached
- or
- $V_{BUS}=V_{SP}$.

If V_{BUS} collapses to V_{SP} when the current is ramping up, the FAN54015 charge with an input current that keeps $V_{\text{BUS}}=V_{\text{SP}}$. When the V_{SP} control loop is limiting the charge current, the SP bit (REG5[4]) is set.

Table 8. V_{SP} as Function of SP Bits (REG5[2:0])

SP (REG5[2:0])			
DEC	BIN	HEX	V_{SP}
0	000	00	4.213
1	001	01	4.293
$\overline{2}$	010	02	4.373
3	011	03	4.453
4	100	04	4.533
5	101	05	4.613
6	110	06	4.693
7	111	07	4.773

Safety Settings

FAN54015 contain a SAFETY register (REG6) that prevents the values in OREG (REG2[7:2]) and IOCHARGE (REG4[6:4]) from exceeding the values of the VSAFE and ISAFE values.

After V_{BAT} exceeds V_{SHORT} , the SAFETY register is loaded with its default value and may be written only before any other register is written. The entire desired Safety register value should be written twice to ensure the register bits are set. After writing to any other register, the SAFETY register is locked until V_{BAT} falls below V_{SHORT} .

The ISAFE (REG6[6:4]) and VSAFE (REG6[3:0]) registers establish values that limit the maximum values of locharge and V_{OREG} used by the control logic. If the host attempts to write a value higher than VSAFE or ISAFE to OREG or IOCHARGE, respectively; the VSAFE, ISAFE value appears as the OREG, IOCHARGE register value, respectively.

Table 9. ISAFE (IOCHARGE Limit) as Function of ISAFE Bits (REG6[6:4])

Table 10. VSAFE (VOREG Limit) as Function of VSAFE Bits (REG6[3:0])

Thermal Regulation and Protection

When the IC's junction temperature reaches T_{CF} (about 120°C), the charger reduces its output current to 550 mA to prevent overheating. If the temperature increases beyond T_{SHUTDOWN}; charging is suspended, the FAULT bits are set to 101, and STAT is pulsed HIGH. In Suspend Mode, all timers stop and the state of the IC's logic is preserved. Charging resumes at programmed current after the die cools to about 120°C.

Additional θ_{JA} data points, measured using the FAN54015 evaluation board, are given in [Table 11](#page-24-1) (measured with $T_A = 25^{\circ}$ C). Note that as power dissipation increases, the effective θ_{JA} decreases due to the larger difference between the die temperature and ambient.

Table 11. Evaluation Board Measured JA

Charge Mode Input Supply Protection

Sleep Mode

When V_{BUS} falls below $V_{BAT} + V_{SLP}$, and V_{BUS} is above V_{IN(MIN)}, the IC enters Sleep Mode to prevent the battery from draining into VBUS. During Sleep Mode, reverse current is disabled by body switching Q1.

Input Supply Low-Voltage Detection

The IC continuously monitors VBUS during charging. If V_{BUS} falls below $V_{IN(MIN)}$, the IC:

- 1. Terminates charging
- 2. Pulses the STAT pin, sets the STAT bits to 11, and sets the FAULT bits to 011.

If V_{BUS} recovers above the $V_{\text{IN(MIN)}}$ rising threshold after time t_{INT} (about two seconds), the charging process is repeated. This function prevents the USB power bus from collapsing or oscillating when the IC is connected to a suspended USB port or a low-current-capable OTG device.

Input Over-Voltage Detection

When the V_{BUS} exceeds VBUS_{OVP}, the IC:

- 1. Turns off Q3
- 2. Suspends charging
- 3. Sets the FAULT bits to 001, sets the STAT bits to 11, and pulses the STAT pin.

When V_{BUS} falls about 150 mV below VBUS_{OVP}, the fault is cleared and charging resumes after V_{BUS} is revalidated *(see VBUS [POR / Non-Compliant Charger Rejection\)](#page-18-0)*.

VBUS Short While Charging

If VBUS is shorted with a very low impedance while the IC is charging with $I_{INLIMIT}=100 \text{ mA}$, the IC may not meet datasheet specifications until power is removed. To trigger this condition, V_{BUS} must be driven from 5 V to GND with a high slew rate. Achieving this slew rate requires a 0 Ω short to the USB cable less than 10cm from the connector.

Charge Mode Battery Detection & Protection

VBAT Over-Voltage Protection

The OREG voltage regulation loop prevents V_{BAT} from overshooting the OREG voltage by more than 50 mV when the battery is removed. When the PWM charger runs with no battery, the TE bit is not set and a battery is inserted that is charged to a voltage higher than V_{OREG} ; PWM pulses stop. If no further pulses occur for 30 ms, the IC sets the FAULT bits to 100, sets the STAT bits to 11, and pulses the STAT pin.

Battery Detection During Charging

The IC can detect the presence, absence, or removal of a battery if the termination bit (TE) is set. During normal charging, once V_{BAT} is close to V_{OREG} and the termination charge current is detected, the IC terminates charging and sets the STAT bits to 10. It then turns on a discharge current, IDETECT, for t_{DETECT}. If V_{BAT} is still above $V_{OREG} - V_{RCH}$, the battery is present and the IC sets the FAULT bits to 000. If V_{BAT} is below $V_{OREG} - V_{RCH}$, the battery is absent and the IC:

- 1. Sets the registers to their default values.
- 2. Sets the FAULT bits to 111.
- 3. Resumes charging with default values after t_{INT} .

Battery Short-Circuit Protection

If the battery voltage is below the short-circuit threshold (V_{SHORT}); a linear current source, I_{SHORT} , supplies V_{BAT} until $V_{BAT} > V_{SHORT}.$

System Operation with No Battery

The FAN54015 continues charging after VBUS POR with the default parameters, regulating the V_{BAT} line to 3.54 V until the host processor issues commands or the 15-minute timer expires. In this way, the FAN54015 can start the system without a battery.

The FAN54015 soft-start function can interfere with the system supply with battery absent. The soft-start activates whenever V_{OREG} , I_{INLIM} , or $I_{OCHARGE}$ are set from a lower to higher value. During soft-start, the I_{IN} limit drops to 100 mA for about 1ms unless I_{INLIM} is set to 11 (no limit). This could cause the system processor to fail to start. To avoid this behavior, use the following sequence.

- 1. Set the OTG pin HIGH. When VBUS is plugged in, I_{INIM} is set to 500 mA until the system processor powers up and can set parameters through $I²C$.
- 2. Program the Safety Register.
- 3. Set I_{INLIM} to 11 (no limit).
- 4. Set OREG to the desired value (typically 4.18).
- 5. Reset the IO LEVEL bit, then set IOCHARGE.
- 6. Set I_{INLIM} to 500mA if a USB source is connected.

During the initial system startup, while the charger IC is being programmed, the system current is limited to 500mA for 1ms during steps 4 and 5. This is the value of the softstart ICHARGE current used when I_{INLM} is set to No Limit.

If the system is powered up without a battery present, the CV bit should be set. When a battery is inserted, the CV bit is cleared.

Charger Status / Fault Status

The STAT pin indicates the operating condition of the IC and provides a fault indicator for interrupt driven systems.

Table 12. STAT Pin Function

The FAULT bits (R0[2:0]) indicate the type of fault in Charge Mode *(see [Table 13\)](#page-25-1)*.

Table 13. Fault Status Bits During Charge Mode

Charge Mode Control Bits

1 | 1 | 1 | No Battery

Setting either HZ_MODE or \overline{CE} through I²C disables the charger and puts the IC into High-Impedance Mode and resets t_{32S} . If V_{BAT} < V_{LOWV} while in High-Impedance Mode, t_{32S} begins running and, when it overflows, all registers (except SAFETY) reset, which enables t_{15MIN} charging on versions with the 15-minute timer.

When t_{15MIN} overflows, the IC sets the CE bit and the IC

enters High-Impedance Mode. If CE was set by t_{15MIN} overflow, a new charge cycle can only be initiated through I ²C or VBUS POR.

Setting the RESET bit clears all registers. If HZ_MODE or

CE bits were set when the RESET bit is set, these bits are also cleared, but the t_{32S} timer is not started, and the IC remains in High-Impedance Mode.

Table 14. DISABLE Pin and CE Bit Functionality

Raising the DISABLE pin stops t_{32S} from advancing, but does not reset it. If the DISABLE pin is raised during t_{15MIN} charging, the t_{15MIN} timer is reset.

Operational Mode Control

OPA_MODE (REG1[0]) and the HZ_MODE (REG1[1]) bits in conjunction with the FAULT state define the operational mode of the charger.

Table 15. Operation Mode Control

HZ_MODE OPA_MODE FAULT Operation Mode

The IC resets the OPA_MODE bit whenever the boost is deactivated, whether due to a fault or being disabled by setting the HZ_MODE bit.

Boost Mode

Boost Mode can be enabled if the IC is in 32-Second Mode with the OTG pin and OPA_MODE bits as indicated in [Table](#page-25-0) [16.](#page-25-0) The OTG pin ACTIVE state is 1 if OTG_PL=1 and 0 when OTG_PL=0.

If boost is active using the OTG pin, Boost Mode is initiated even if the HZ_MODE=1. The HZ_MODE bit overrides the OPA_MODE bit.

To remain in Boost Mode, the TMR_RST must be set by the host before the t_{32S} timer times out. If t_{32S} times out in Boost Mode; the IC resets all registers, pulses the STAT pin, sets the FAULT bits to 110, and resets the BOOST bit. VBUS POR or reading R0 clears the fault condition.

Boost PWM Control

The IC uses a minimum on-time and computed minimum offtime to regulate VBUS. The regulator achieves excellent transient response by employing current-mode modulation. This technique causes the regulator to exhibit a load line. During PWM Mode, the output voltage drops slightly as the input current rises. With a constant V_{BAT} , this appears as a constant output resistance.

The "droop" caused by the output resistance when a load is applied allows the regulator to respond smoothly to load transients with no undershoot from the load line. This can be seen i[n Figure 31](#page-15-0) and [Figure 40.](#page-26-0)

V_{BUS} as a function of I_{LOAD} can be computed when the regulator is in PWM Mode (continuous conduction) as:

 $V_{\text{OUT}} = 5.07 - R_{\text{OUT}} \cdot I_{\text{LOAD}}$ EQ. 1

At $V_{BAT}=3.3$ V, and $I_{LOAD}=200$ mA, V_{BUS} would drop to:

$$
V_{\text{OUT}} = 5.07 - 0.26 \cdot 0.2 = 5.018V
$$
 Eq. 1A

At $V_{BAT}=2.7$ V, and $I_{LOAD}=200$ mA, V_{BUS} would drop to:

$$
V_{\text{OUT}} = 5.07 - 0.327 \cdot 0.2 = 5.005V
$$

PFM Mode

If V_{BUS} > VREF_{BOOST} (nominally 5.07 V) when the minimum off-time has ended, the regulator enters PFM Mode. Boost pulses are inhibited until V_{BUS} < VREF_{BOOST}. The minimum on-time is increased to enable the output to pump up sufficiently with each PFM boost pulse. Therefore the regulator behaves like a constant on-time regulator, with the bottom of its output voltage ripple at 5.07 V in PFM Mode.

Table 17. Boost PWM Operating States

Startup

When the boost regulator is shut down, current flow is prevented from V_{BAT} to V_{BUS} , as well as reverse flow from V_{BUS} to V_{BAT}.

LIN State

When EN rises, if $V_{BAT} > UVLO_{BST}$, the regulator first attempts to bring PMID within 400 mV of V_{BAT} using an internal 450 mA current source from VBAT (LIN State). If PMID has not achieved V_{BAT} – 400 mV after 560 μ s, a FAULT state is initiated.

SS State

When PMID > V_{BAT} – 400 mV, the boost regulator begins switching with a reduced peak current limit of about 50% of its normal current limit. The output slews up until V_{BUS} is within 5% of its setpoint; at which time, the regulation loop is closed and the current limit is set to 100%.

If the output fails to achieve 95% of its setpoint (V_{BST}) within 128 μ s, the current limit is increased to 100%. If the output fails to achieve 95% of its setpoint after this second $384\mu s$ period, a fault state is initiated.

BST State

This is the normal operating mode of the regulator. The requlator uses a minimum t_{OFF} -minimum t_{ON} modulation

scheme. The minimum t_{OFF} is proportional to Vout V_{IN}

keeps the regulator's switching frequency reasonably constant in CCM. t_{ON(MIN)} is proportional to V_{BAT} and is a higher value if the inductor current reached θ before to $F_F(M|N)$ in the prior cycle.

To ensure the VBUS does not pump significantly above the regulation point, the boost switch remains off as long as $FB > V_{REF}$.

Boost Faults

If a BOOST fault occurs:

- 1. The STAT pin pulses.
- 2. OPA_MODE bit is reset.
- 3. The power stage is in High-Impedance Mode.
- 4. The FAULT bits (REG0[2:0]) are set per [Table 18.](#page-26-2)

Restart After Boost Faults

If boost was enabled with the OPA_MODE bit and OTG_EN=0, Boost Mode can only be enabled through subsequent I^2C commands since OPA_MODE is reset on boost faults. If OTG_EN=1 and the OTG pin is still ACTIVE *(see [Table 16\)](#page-25-0),* the boost restarts after a 5.2 ms delay, as shown in [Figure 41.](#page-27-0) If the fault condition persists, restart is attempted every 5ms until the fault clears or an I^2C command disables the boost.

Table 18. Fault Bits During Boost Mode

VREG Pin

The 1.8 V regulated output on this pin can be disabled through I^2C by setting the DIS_VREG bit (REG5[6]). VREG can supply up to 2 mA. This circuit, which is powered from PMID, is enabled only when PMID > V_{BAT} and does not drain current from the battery. During boost, V_{REG} is off. It is also off when the HZ_MODE bit (REG1[1])=1.

Monitor Register (Reg10H)

Additional status monitoring bits enable the host processor to have more visibility into the status of the IC. The monitor bits are real-time status indicators and are not internally debounced or otherwise time qualified.

The state of the MONITOR register bits listed in High-Impedance Mode is only valid when V_{BUS} is valid.

Table 19. MONITOR Register Bit Definitions

I ²C Interface

The FAN54015's serial interface is compatible with Standard, Fast, Fast Plus, and High-Speed Mode I²C-Bus® specifications. The SCL line is an input and the SDA line is a bi-directional open-drain output; it can only pull down the bus when active. The SDA line only pulls LOW during data reads and signaling ACK. All data is shifted in MSB (bit 7) first.

Slave Address

Table 20. I²C Slave Address Byte

In hex notation, the slave address assumes a 0 LSB. The hex slave address for the FAN54015 is D4H and is D6H for all other parts in the family.

Bus Timing

As shown in [Figure 42,](#page-28-0) data is normally transferred when SCL is LOW. Data is clocked in on the rising edge of SCL. Typically, data transitions shortly at or after the falling edge of SCL to allow ample time for the data to set up before the next SCL rising edge.

Figure 42. Data Transfer Timing

Each bus transaction begins and ends with SDA and SCL HIGH. A transaction begins with a START condition, which is defined as SDA transitioning from 1 to 0 with SCL HIGH, as shown in [Figure 43.](#page-28-1)

Figure 43. Start Bit

A transaction ends with a STOP condition, which is defined as SDA transitioning from 0 to 1 with SCL HIGH, as shown in [Figure 44.](#page-28-2)

During a read from the FAN54015 [\(Figure 46,](#page-29-0) [Figure 47\)](#page-29-1), the master issues a Repeated Start after sending the register address and before resending the slave address. The Repeated Start is a 1-to-0 transition on SDA while SCL is HIGH, as shown in [Figure 45.](#page-28-3)

High-Speed (HS) Mode

The protocols for High-Speed (HS), Low-Speed (LS), and Fast-Speed (FS) Modes are identical except the bus speed for HS Mode is 3.4 MHz. HS Mode is entered when the bus master sends the HS master code 00001XXX after a start condition. The master code is sent in Fast or Fast Plus Mode (less than 1 MHz clock); slaves do not ACK this transmission.

The master then generates a repeated start condition [\(Figure 45\)](#page-28-3) that causes all slaves on the bus to switch to HS Mode. The master then sends I^2C packets, as described above, using the HS Mode clock rate and timing.

The bus remains in HS Mode until a stop bit [\(Figure 44\)](#page-28-2) is sent by the master. While in HS Mode, packets are separated by repeated start conditions [\(Figure 45\)](#page-28-3).

Figure 45. Repeated Start Timing

Read and Write Transactions

The figures below outline the sequences for data read and write. Bus control is signified by the shading of the packet,

All addresses and data are MSB first.

Table 21. Bit Definitions for [Figure 46,](#page-29-0) [Figure 47,](#page-29-1) and [Figure 48](#page-32-0)

Register Descriptions

The nine FAN54015 user-accessible registers are defined in [Table 22.](#page-29-2)

Table 22. I ²C Register Address

Table 23. Register Bit Definitions

This table defines the operation of each register bit for all IC versions. Default values are in **bold** text.

Continued on the following page…

Continued on the following page…

[Table 23. Register Bit Definitions](#page-29-3) (Continued)

FAN54015

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PCB Layout Recommendations

Bypass capacitors should be placed as close to the IC as possible. In particular, the total loop length for CMID should be minimized to reduce overshoot and ringing on the SW, PMID, and VBUS pins. All power and ground pins must be

routed to their bypass capacitors, using top copper whenever possible. Copper area connecting to the IC should be maximized to improve thermal performance if possible.

Figure 48. PCB Layout Recommendations

Regulator

FAN54015

FAN54015

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Product-Specific Dimensions

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PRODUCT STATUS DEFINITIONS

Rev. 166

FAN54015 — AN54015 l USB-Conniclation Single-Cell Li-lon Spaces Represent USB-OTG Boost Regulator **USB-Compliant Single-Cell Li-Ion Switching Charger with USB-OTG Boost Regulator**

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